

New Product

Vishay Siliconix

P-Channel 30-V (D-S) MOSFET

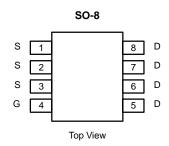
PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)			
-30	0.012 @ V _{GS} = -10 V	-11.4			
	0.019 @ V _{GS} = -4.5 V	- 9.1			

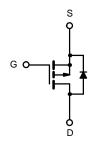
FEATURES

- TrenchFET® Power MOSFET
- Advanced High Cell Density Process

APPLICATIONS

- Load Switches
 - Notebook PCs
 - Desktop PCs





P-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S (T _A = 25°C UN	ILESS OTHI	ERWISE NO	TED)	
Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		V _{DS}	-30		.,
Gate-Source Voltage		V _{GS}	±20		V
Continuous Drain Current (T _{.I} = 150°C) ^a	T _A = 25°C	la la	- 11.4	-8.8	А
Continuous Brain Current (1) = 130 C)	T _A = 70°C	_ I _D	- 9.1	-7.0	
Pulsed Drain Current		I _{DM}	-50		Λ,
continuous Source Current (Diode Conduction) ^a		IS	-2.1	-1.3	
Maximum Power Dissipation ^a	T _A = 25°C	-	2.5	1.5	10/
	T _A = 70°C	P _D	1.6	0.9	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
	t ≤ 10 sec	R _{thJA}	40	50	°C/W
Maximum Junction-to-Ambient ^a	Steady State		70	85	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	15	18	

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

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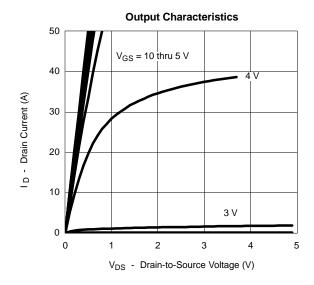
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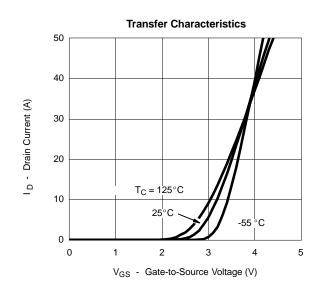


SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)								
Parameter	Symbol	Test Condition		Тур	Max	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1.0		-3.0	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA		
Zoro Coto Voltogo Proin Current	1	$V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}$			-1			
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			-5	μΑ		
On-State Drain Currenta	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-50			Α		
Danier Courses On Chata Basistanas	_	V _{GS} = -10 V, I _D = -11.4 A		0.010	0.012			
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -9.1 \text{ A}$		0.015	0.019	Ω		
Forward Transconductancea	9 _{fs}	V _{DS} = -15 V, I _D = -11.4 A		29		S		
Diode Forward Voltage ^a	V _{SD}	I _S = -2.5 A, V _{GS} = 0 V		-0.8	-1.2	V		
Dynamic ^b	<u> </u>							
Total Gate Charge	Qg			64	100			
Gate-Source Charge	Q _{gs}	V_{DS} = -15 V, V_{GS} = -10 V, I_D = -11.4 A		11		nC		
Gate-Drain Charge	Q _{gd}			17				
Turn-On Delay Time	t _{d(on)}			15	25			
Rise Time	t _r	$V_{DD} = -15 \text{ V, R}_{L} = 15 \Omega$		13	20	1		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -1 \text{ A}, V_{GEN} = -10 \text{ V}, R_G = 6 \Omega$		100	150	ns		
Fall Time	t _f			53	80			
Source-Drain Reverse Recovery Time	t _{rr}	I _F = -2.5 A, di/dt = 100 A/μs		41	80	1		

 $\begin{array}{ll} \text{Notes} \\ \text{a.} & \text{Pulse test; pulse width} \leq 300~\mu\text{s, duty cycle} \leq 2\%. \\ \text{b.} & \text{Guaranteed by design, not subject to production testing.} \end{array}$

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



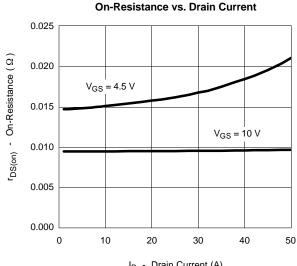




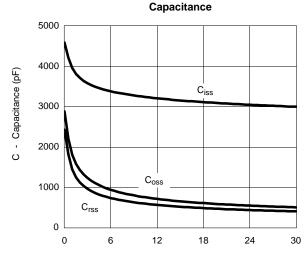
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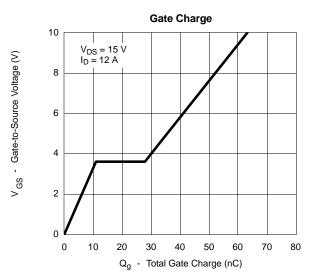
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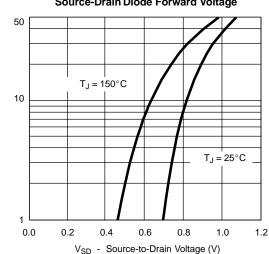
ID - Drain Current (A)



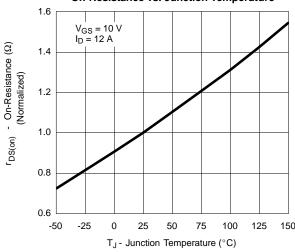
V_{DS} - Drain-to-Source Voltage (V)



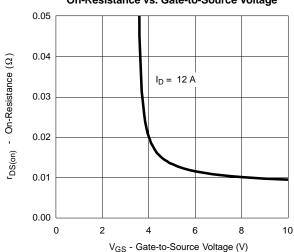
Source-Drain Diode Forward Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

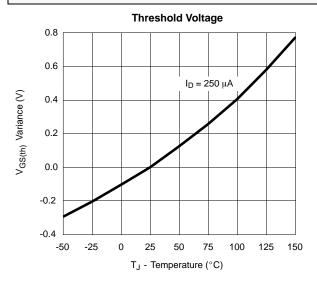


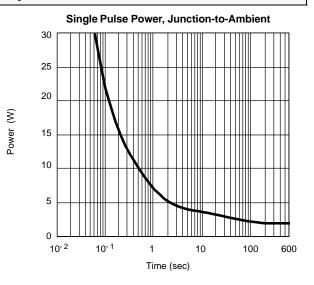
S - Source Current (A)

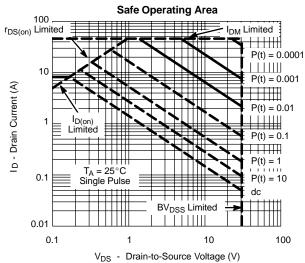
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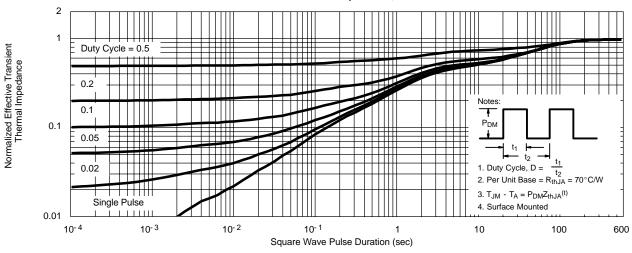
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)







Normalized Thermal Transient Impedance, Junction-to-Ambient



10

1



2

0.1

0.01 10-4

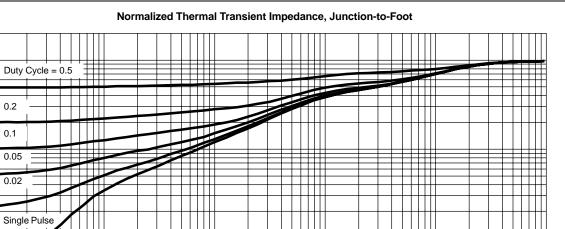
Normalized Effective Transient Thermal Impedance

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TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

10⁻³



10-1

10-2

Square Wave Pulse Duration (sec)